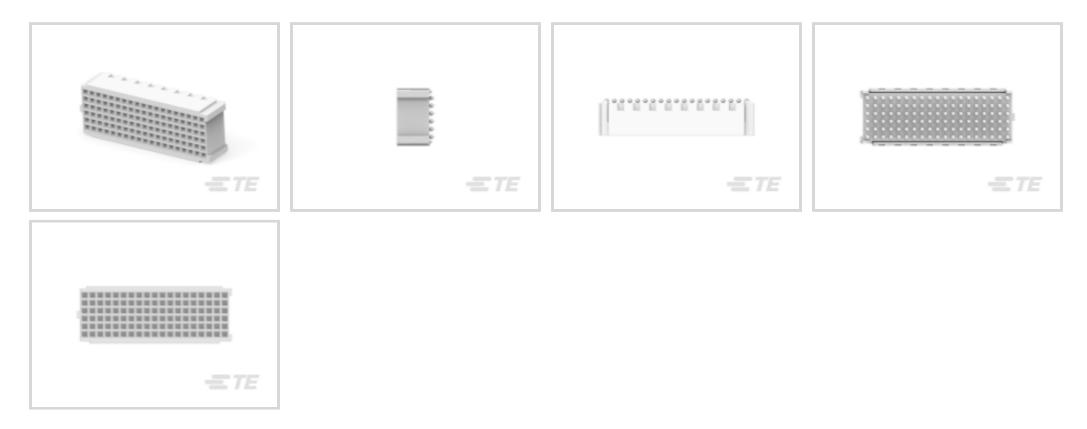


Mezalok HSLF

TE Internal #: 2355825-1 Mezalok HSLF, PCB Mount Receptacle, Vertical, Board-to-Board, 114 Position, .05 in [1.27 mm] Centerline, Gold, Surface Mount -Solder Ball, Signal

View on TE.com >

Connectors > PCB Connectors > PCB Connector Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Vertical

Connector System: Board-to-Board

Number of Positions: 114

Number of Rows: 6

Features

connectivity

Product Type Features

PCB Connector Assembly Type	PCB Mount Receptacle				
Connector System	Board-to-Board				
Sealable	No				
Connector & Contact Terminates To	Printed Circuit Board				
Configuration Features					
Stackable	Yes				
PCB Mount Orientation	Vertical				
Number of Positions	114				
Number of Rows	6				
Board-to-Board Configuration	Parallel				
Electrical Characteristics					
Dielectric Withstanding Voltage (Max)	750 VAC				
Operating Voltage	250 VAC				
Body Features					

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Primary Product Color	Natural	
Contact Features		
Contact Layout	Matrix	
Mating Tab Width	.43 mm[.017 in]	
Mating Tab Thickness	.46 mm[.018 in]	
PCB Contact Termination Area Plating Material	Tin-Lead	
Contact Base Material	Beryllium Copper	
Contact Mating Area Plating Material	iting Material Gold	
Contact Mating Area Plating Material Thickness	50 μm[50 μin]	
Contact Type	Socket	
Contact Current Rating (Max)	1.5 A	
Termination Features		
Termination Method to Printed Circuit Board	Surface Mount - Solder Ball	
Mechanical Attachment		
Mating Alignment	With	
Mating Alignment Type	Keyed	
PCB Mount Retention	Without	
PCB Mount Alignment	Without	
Connector Mounting Type	Board Mount	
Housing Features		
Centerline (Pitch)	1.27 mm[.05 in]	
Housing Material	LCP	
Dimensions		
Connector Height	6 mm[.236 in]	
Row-to-Row Spacing	1.27 mm[.05 in]	
Stack Height	10 mm[.394 in]	
Usage Conditions		
Operating Temperature Range	-55 – 125 °C[-67 – 257 °F]	
Operation/Application		
Assembly Process Feature	Pick and Place Cover	
Circuit Application	Signal	

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Industry Standards

Industry Standard	VITA 61			
UL Flammability Rating	UL 94V-0			
Packaging Features				
Packaging Quantity	450			
Packaging Type	Tape & Reel			

Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUL 2021 (219) Candidate List Declared Against: JUN 2020 (209) SVHC > Threshold: Pb (36.09% in SOLDERBALL) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable

Halogen Content

Not Yet Reviewed for halogen content

governmental regulations relevant to your geographic location.

Solder Process Capability

Not reviewed for solder process capability

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts

Mezalok HSLF, PCB Mount Receptacle, Vertical, Board-to-Board, 114 Position, .05 in [1.27 mm] Centerline, Gold, Surface Mount - Solder Ball, Signal





Also in the Series | Mezalok HSLF



PCB Connector Headers & Receptacles (21)

Customers Also Bought



	TE		
TE Part #1-928836-2 MOD2 PIN WITH A-PIN L/P	TE Part #7-2176246-6 CRGS2512 5% 1M8	TE Part #1761072-3 RECPT,HSSDC2,FIBRE,TRAY PKG	TE Part #3-1415020-1 PT570N20



Documents

Product Drawings Mezalok, Socket, 114 p, 10 mm, 50 Au,

English

CAD Files

3D PDF

3D

Mezalok HSLF, PCB Mount Receptacle, Vertical, Board-to-Board, 114 Position, .05 in [1.27 mm] Centerline, Gold, Surface Mount - Solder Ball, Signal



Customer View Model

ENG_CVM_CVM_2355825-1_1.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_2355825-1_1.3d_igs.zip

English

Customer View Model

ENG_CVM_CVM_2355825-1_1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Product Specifications Product Specification

English

Product Specification

English